

Our experience, your advantage

AGS20 SERIES

Universal Aggregation Platform

AGS20 is a Universal Microwave Aggregation Platform that flexibly addresses the different RAN generation needs over a common wireless transport infrastructure, including LTE-Advanced and 5G new stringent requirements. The AGS20 is a family of microwave aggregators with multiple mechanical arrangements designed to fit different needs and deployment scenarios in a modern mobile backhaul infrastructure. The ASNK ODU is extremely compact in size with less than 2 liters volume and with a benchmarking power consumption of 10W, help operators in diminishing CO2 emissions.

AGS20 addresses the need for carrier-class multi-technology traffic aggregation, with high performance Carrier Ethernet 2.0 and IP/MPLS engine, with multiple 1/2,5/10Gbps ports, while maintaining full support of the legacy traffic E1 and STM-1 services.

The platform enables convergence of the major microwave application segments:

- Next Generation indoor unit for advanced packet processing
- Aggregation of IF and All-Outdoor Radio including E-Band
- Modular configuration for evolving complex sites



COMPANY WITH QUALITY SYSTEM CERTIFIED BY DNV GL = ISO 9001:2015 =

AGS20 SERIES Product Leaflet

Data subject to change without notice - Not contractually binding | May 2019 © All rights reserved @ SIAE MICROELETTRONICA

UNIVERSAL PRODUCT ARCHITECTURE

Microwave radio products have evolved in terms of functionality and physical arrangements to cover in an effective and efficient way they can be employed in any application.

AGS20 as part of the SIAE MICROELETTRONICA Unified Product Architecture, utilizes at its core the SM-OS operating system based over three major components:

Network Management Plane

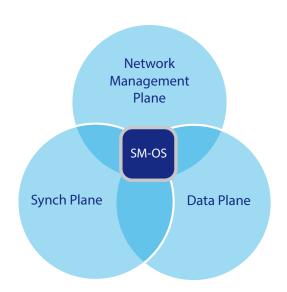
- NETCONF/Yang in SDN deployment
- SNMP v1/v2c/v3, HTTPs, SSH, SFTP
- RADIUS for centralized user management

Data Plane

- MEF 2.0 Carrier Ethernet Services
- IP/MPLS L2/L3 VPN Services
- QoS/HQoS queue management/policing and shaping

Synch Plane

- Synchronous Ethernet
- ITU-T G.8275.1 Profiles (T-BC)
- 1 PPS in/out port



NEXT GENERATION UNIT FOR SPLIT MOUNT RADIO

AGS20 sets a new industry benchmark in split mount microwave by featuring the following capabilities:

- Modulation up to 4096 QAM
- Channel spacing up to 112 MHz
- Lower than 2 Litre volume for easier installation
- Multicarrier Aggregation for Hybrid Link (standard licensed frequency band and a millimeter wave 80 GHz band)





SM siae microelettronica

FAMILY PORTFOLIO

AGS20 series is the state of art microwave radio solution. AGS20 include three physical mechanical arrangements to satisfy simple point to point needs to the most complex sites including nodal configurations and scaling capacity in line with network growth.

The IDU can support a variety of interfaces with a mix of GE and Radio IF interfaces, for maximum flexibility when interconnecting heterogeneous technologies.

AGS20

AGS20 is a fully integrated single box solution. It offers a complete range of interfaces: Radio, 10/2.5/1 Gigabit/Fast Ethernet, E1 both native and pseudo wire and STM-1.

AGS20 can support up to four IF interfaces, allowing the set up a four direction nodal solution in a single rack unit IDU, or Radio LAG over 4x ODUs, with best cost/performance relationship. AGS20 minimizes space consumption without renouncing to functionalities.



AGS20M

AGS20M is an expandable split-mount edge node that hosts a frontal expansion slot. Its innovative structure provides both simplicity and flexibility matching the requirement of maintaining a low total cost of ownership (TCO) by giving the possibility to expand the node with more radio or client interfaces to meet the growing demands of the network.



AGS20L

AGS20L has a fully modular architectural design, addressing dense scenario applications where multiple directions, high capacity aggregation and convergence over the optical network are a need.

AGS20L aggregates traffic incoming from multiple IF based ODU and Ethernet based full outdoors, all feeding into a single node. Its modular design offers full redundancy (no Single Point of Failure) regardless of the radio configuration, improving resiliency of aggregation and backbone sites.





MAIN FEATURES

- SM-OS based platform
- 4 to 4096 QAM modulation
- Hitless Adaptive Code and Modulation
- Multi Layer Header Compression
- L1 Radio LAG over multiple ODU with XPIC
- Extended Ethernet connectivity: multiple 10/2,5/GE interfaces

- Multi Carrier Aggregation
- Mixed TDM/Ethernet interfaces for dual native transport
- PWE3 TDM services defined by software for full packet networks
- AES128/256 Encryption
- POE support
- Extended buffer for maximum TCP/ IP efficiency in LTE networks

- Integrated antennas up to 1.8m (6ft)
- Single Universal ODU for any capacity and modulation
- Network Management System: NMS5
- SDN Microwave Domain Controller: SM-DC

LAYER 2 MAIN FUNCTIONALITIES

- MEF 2.0 certified
- 8 queues with flexible scheduler (Strict Priority, WRR and mixed)
- 4 level hierarchical scheduler (H-QoS)
- Flexible QoS definition based on VLAN, IPv4, IPv6, MPLS exp bits
- Per queue WRED congestion
 avoidance
- Flow Based Ingress Policing (CIR & EIR definition)
- Egress shaping
- Ethernet Ring Protection G.8032
- RMON statistics per service VLAN stacking (IEEE 802.1ad QinQ)
- Link Aggregation IEEE 802.3ad
- Ethernet OAM 802.3ah/ 802.1ag/ Y.1731
- Jumbo Frames up to 12 Kbytes

LAYER 3 MAIN FUNCTIONALITIES

- LDP (Label Distribution Protocol) / TLDP
- RSVP/RSVP-TE
- MPLS L2VPN / VPLS
- MPLS L3VPN
- MPLS TE using RSVP-TE

- OSPFv2 and OSPF with TE extension
- BGPv4, MP-BGP
- IS-IS
- eBGP
- BDF bidirectional forwarding detection for PW VCCV
- FRR Fast Re-route
- LSP RSVP-TE protection 1:1
- MPLS-OAM (with MPLS-TP)



SIAE MICROELETTRONICA via Michelangelo Buonarroti, 1 20093 Cologno Monzese, Milano Tel. +39 02273251 - Fax +39 0225391585

AGS20	1xIF	2xIF	4xIF							
Configuration	1+0	1+0 / 1+1 / 2+0 XPIC radio LAG	1+0 / 1+1 / 2+0 / 4+0 XPIC radio LAG							
Switching capability	46 Gbps full duplex									
TDM transmission capability	Up to126 x E1 (per radio direction)									
Modulation	4 QAM to 4096 QAM with hitless ACM									
Ethernet/Radio interfaces	1 x IF (ODU) 2 x GE electrical 4 x GE SFP (1 / 2.5 Gbps) 2 x GE Combo (electrical /optical)	2 x IF (ODU) 2 x GE electrical 4 x GE SFP (1 / 10 / 2.5 Gbps) 2 x GE Combo (electrical / optical)	4 x IF (ODU) 2 x GE electrical 2x GE SFP (1 / 10 / 2.5 Gbps) 2 x GE Combo (electrical / optical)							
TDM interfaces (optional)	16x E1 native / PWE3 mode software selectable 2x STM-1 native NBUS (nodal expansion)									
Local maintenance interfaces	Console port / LAN port									
Synchronization interfaces	1pps / ToD / 2048 KHz									

AGS20M								
Configuration	1+0 / 2+0 / 4+0 / 1+1 / 2+2/ XPIC / radio LAG							
Switching capability	53 Gbps full duplex							
TDM transmission capability	Up to126 x E1 (per radio direction)							
Modulation	4 QAM to 4096 QAM with hitless ACM							
Ethernet/Radio interfaces Main board unit	2 x IF Module 4 x 10Gbps, 4xGE, 2 x GE SFP 8xE1 Native or PWE3							
Expansion unit	2 x IF Module							
Local maintenance interfaces	Console port / LAN port							
Synchronization interfaces	1pps / ToD / 2048 KHz							

AGS20L							
Configuration		1+0 / 2+0 / 4+0 / 8+0 / 1+1 / 2+2/ 4+4/ XPIC / radio LAG					
Switching capability		100 Gbps full duplex					
TDM transmission capability		Up to126 x E1 (per radio direction)					
Modulation		4 QAM to 4096 QAM with hitless ACM					
Units							
	Core card	2 x 10Gbps + 2 x 100Base T for DCN					
	DRI-2 card	2 x 10 Gbps Module					
	ARI-2 card	2 x IF Module					
	DRI-8 card	8xGE (4 x GE electrical + 4 x GE SFP)					
	TDM card	8xE1 + 2 STM-1					
	FAN card	Up to 2 module per IDU					
	PSU card	Nominal -48VDC					
Local maintenance interfaces		Console port / LAN port					
Synchronization interfaces		1pps / ToD / 2048 KHz					

AGS20 SERIES Product Datasheet

Data subject to change without notice - Not contractually binding | May 2019 © All rights reserved @ SIAE MICROELETTRONICA

Frequeny ba	and	4 GHz	6L/6U GHz	7/8 GHz	10/11 GHz	13 GHz	15 GHz	18 GHz	23 GHz	26 GHz	28 GHz	32 GHz	38 GHz	42 Ghz
Frequency ra	ange	4.4-5	5.9-7.1	7.11-8.5	10.2-11.7	12.7-13.2	14.4-15.3	17.7-19.7	21.2-23.6	24.5-26.5	27.5-29.5	32.8-33.4	37-39.5	40.5-43.5
Modulation	schemes		4 QAM / 1	6 QAM / 3	32 QAM / 6	4 QAM / 1	28 QAM /	256 QAM	/ 512QAN	Л / 1024 C) AM / 2048	 8 QAM / 4(096 QAM	
Channel spa	acing	4 QAM / 16 QAM / 32 QAM / 64 QAM / 128 QAM / 256 QAM / 512QAM / 1024 QAM / 2048 QAM / 4096 QAM 7 MHz / 14 MHz / 28 MHz / 40 MHz / 56 MHz / 112 MHz												
Throughput		Up to 1Gbs per radio channel												
Output pow	ver (dBm) at point	C'*												
	4 QAM	+28	+32	+29	+30	+28	+28	+23	+23	+22	+21	+20	+19	+17
	16 QAM	+25	+29	+26	+27	+25	+25	+21	+21	+20	+19	+18	+17	+15
	32 QAM	+25	+29	+26	+27	+25	+25	+21	+21	+20	+19	+18	+17	+15
	64 QAM	+24	+28	+25	+26	+24	+24	+19	+19	+18	+17	+16	+15	+13
	128 QAM	+24	+28	+25	+26	+24	+24	+19	+19	+18	+17	+16	+15	+13
	256 QAM	+23	+27	+24	+24	+23	+23	+18	+18	+17	+16	+15	+14	+12
	512 QAM	+23	+27	+24	+25	+23	+23	+18	+18	+17	+16	+15	+14	+12
	1024 QAM	+22	+26	+23	+24	+22	+22	+17	+17	+16	+15	614	+13	+11
	2048 QAM	+22	+26	+23	+24	+22	+22	+17	+17	+16	+15	614	+13	+11
	4096 QAM	+21	+25	+22	+23	+21	+21	+16	+16	+15	+14	+13	+12	-
Receiver sen	sitivity (dBm) at B	ER 10 ⁻⁶ at	Point C (1	+0, 28 MF	Hz BW, RF f	ilter losse	s included	1)						
	4 QAM	-87	-88.5	-88.5	-88	-88	-88	-87.5	-87.5	-87	-85.5	-85	-85.5	-84.5
	16 QAM	-81	-82.5	-82.5	-82	-82	-82	-81.5	-81.5	-81	-79.5	-79	-79.5	-78.5
	32 QAM	-76.5	-78	-78	-77.5	-77.5	-77.5	-77	-77	-76.5	-75	-74.5	-75	-74
	64 QAM	-73.5	-75	-75	-74.5	-74.5	-75.5	-74	-74	-73.5	-72	-71.5	-72	-71
	128 QAM	-70.5	-72	-72	-71.5	-71.5	-71.5	-71	-71	-70.5	-69	-68.5	-69	-68
	256 QAM	-67.5	-69	-69	-68.5	-68.5	-68.5	-68	-68	-67.5	-66	-65.5	-66	-65
	512 QAM	-65.5	-67	-67	-65.5	-65.5	-65.5	-66	-66	-65.5	-64	-63.5	-64	-63
	1024 QAM	-62	-63.5	-63.5	-63	-63	-63	-62.5	-62.5	-62	-60.5	-60	-60.5	-59.5
	2048 QAM	-59	-60.5	-60.5	-60	-60	-60	-59.5	-59.5	-59	-57.5	-57	-57.5	-56.5
	4096 QAM	-56	-57.5	-57.5	-57	-57	-57	-56.5	-56.5	-56	-54.5	-54	-54.5	-
Frequency st	tability							±5 ppm						
Frequency a						250) KHz (sof	tware prog	grammabl	e)				
RTPC							Up to	30 in 1 dB	steps					
ATPC							Up to	30 in 1 dB	steps					
IDU/ODU int	terconnection													
per terminal							5002	Coaxial Ca	ble					
Dimensions	(WxHxD)													
	AGS20	442 x 44 x 223 (mm) / 17.4 x 1.7 x 8.7 (in)												
	AGS20M	442 x 44 x 240 (mm) / 17.4 x 1.7 x 9.4 (in)												
	AGS20L	442 x 88 x 240 (mm) / 17.4 x 3.4 x 9.4 (in)												
ODL	J (below 18 GHz)	254 x 254 x 114 (mm) / 10 x 10 x 4.5 (in)												
OD	0U (18 to 42 GHz)	182 x 182 x 65 (mm) / 7.1 x 7.1 x 2.5 (in)												
Power supply -48 Vdc (-15%, +2				-20%)										
Overall pow	er consumption													
	1+0 terminal	I ≤ 45W												
	1+1 terminal	≤ 60 W												
Environmental performance		IDU temperature range: -5°C to +55°C												
			ODU weather proofing class: IP67							ODU temperature range: -35°C to +55°				
A 14:4 1		Working temperature range with performance not guaranteed: -45°C to +60°C												
Altitude		3000 m												
Compliant w	s s					E	ISIEN 30	2 217 / FC	C Part 101					



SIAE MICROELETTRONICA via Michelangelo Buonarroti, 1 20093 Cologno Monzese, Milano Tel. +39 02273251 - Fax +39 0225391585

www.siaemic.com